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SEMICONDUCTOR



ESD



TVS



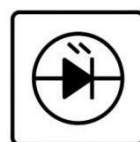
TSS



MOV



GDT



PLED

LM317G-MS

Product specification

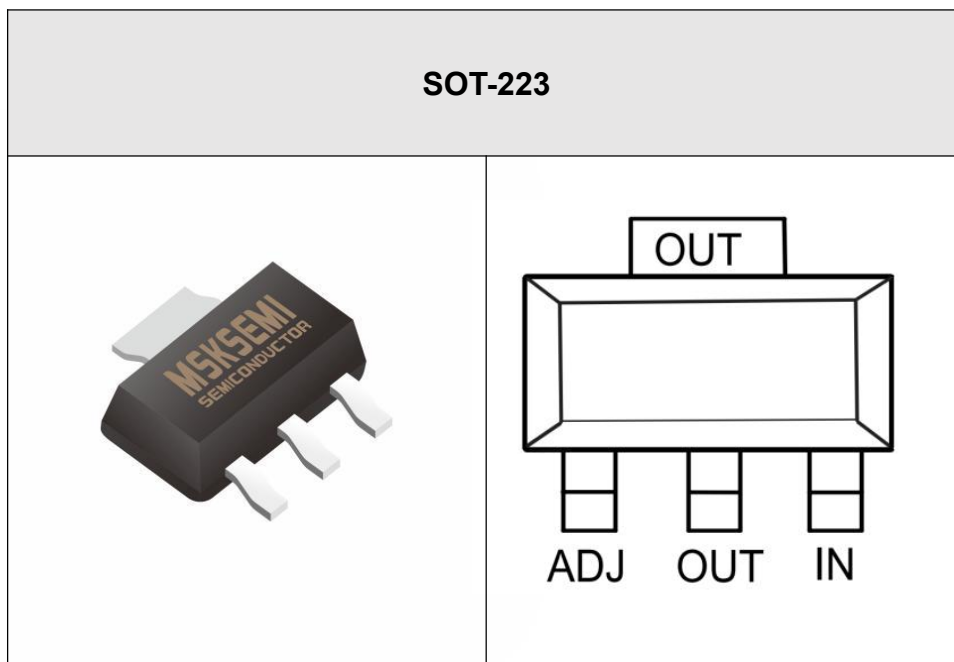
DESCRIPTION

This monolithic integrated circuit is an adjustable 3-terminal positive voltage regulator designed to supply more than 1.5A of load current with an output voltage adjustable over a 1.2 to 37V. It employs internal current limiting, thermal shut-down and safe area compensation.

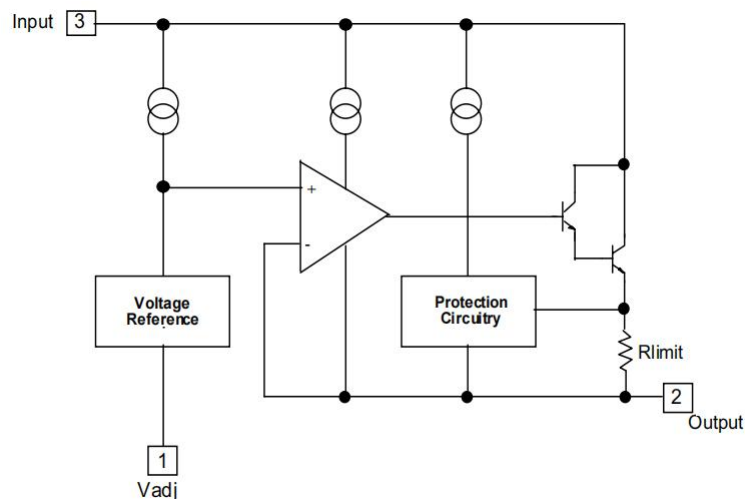
FEATURE

- Internal thermal overload protection
- Internal short circuit current limiting
- Output transistor safe operating area compensation

Reference News



Internal Block Diagram



Absolute Maximum Ratings

Symbol	Parameter	Value	Units
V_I-V_O	Input-Output Voltage Differential	40	V
T_{LEAD}	Lead Temperature	230	°C
P_D	Power Dissipation	Internally limited	W
T_J	Operating Junction Temperature Range	0~125	°C
T_{stg}	Storage Temperature Range	-55~125	
$\Delta V_O/\Delta T$	Temperature Coefficient of Output Voltage	±0.02	%/°C

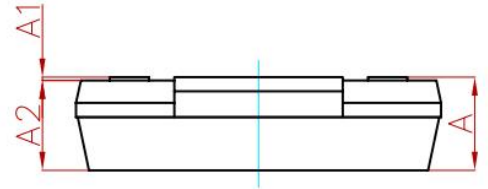
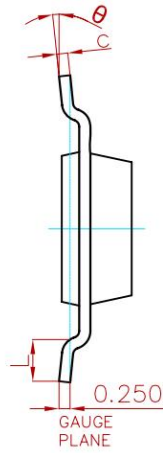
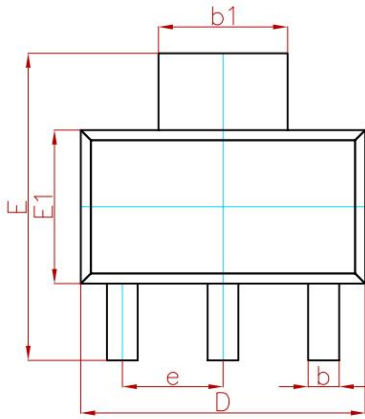
ELECTRICAL CHARACTERISTICS

($V_O-V_I=5V, I_O=0.5A, 0^\circ C \leq T_J \leq +125^\circ C, I_{MAX}=1.5A, P_{DMAX}=20W$, unless otherwise specified)

Parameter	Symbol	Test conditions	MIN	TYP	MAX	UNIT
Line Regulation(note1)	R_{line}	$T_A=25^\circ C$ $3V \leq V_I-V_O \leq 40V$		0.01	0.04	%V
		$3V \leq V_I-V_O \leq 40V$		0.02	0.07	
Load Regulation(note1)	R_{load}	$T_A=25^\circ C, 10mA \leq I_O \leq I_{MAX}$ $V_O < 5V$ $V_O \geq 5V$		18 0.4	25 0.5	mV
		$10mA \leq I_O \leq I_{MAX}$ $V_O < 5V$ $V_O \geq 5V$		40 0.8	70 1.5	% V_O
Adjustable Pin Current	I_{ADJ}	-		46	100	μA
Adjustable Pin Current Change	ΔI_{ADJ}	$3V \leq V_I-V_O \leq 40V$ $10mA \leq I_O \leq I_{MAX}, P_D \leq P_{MAX}$		2.0	5	
Reference Voltage	V_{REF}	$3V \leq V_{IN}-V_O \leq 40V$ $10mA \leq I_O \leq I_{MAX}, P_D \leq P_{MAX}$	1.20	1.25	1.30	V
Temperature Stability	ST_T	-		0.7		%/ V_O
Minimum Load Current to Maintain Regulation	$I_{L(MIN)}$	$V_I-V_O=40V$		3.5	12	mA
Maximum Output Current	$I_{O(MAX)}$	$V_I-V_O \leq 15V, P_D \leq P_{MAX}$ $V_I-V_O \leq 40V, P_D \leq P_{MAX}$ $T_A=25^\circ C$	1.0	2.2 0.3		A
RMS Noise,% of V_{OUT}	N	$T_A=25^\circ C, 10Hz \leq f \leq 10KHz$		0.003	0.01	%/ V_O
Ripple Rejection	RR	$V_O=10V, f=120Hz$ without C_{ADJ} $C_{ADJ}=10\mu F$ (note2)	66	60 75		dB
Long-Term Stability, $T_J=T_{HIGH}$	ST	$T_A=25^\circ C$ for end point mesasurements, 1 0 0 0 HR		0.3	1	%
Thermal Resistance Junction to case	$R_{\theta JC}$	-		5		°C/W

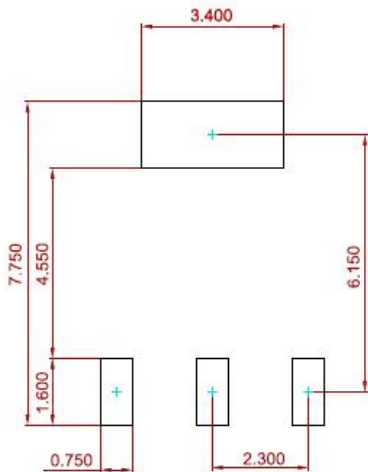
PACKAGE MECHANICAL DATA

SOT-223



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	—	1.800	—	0.071
A1	0.020	0.100	0.001	0.004
A2	1.500	1.700	0.059	0.067
b	0.660	0.840	0.026	0.033
b1	2.900	3.100	0.114	0.122
c	0.230	0.350	0.009	0.014
D	6.300	6.700	0.248	0.264
E	6.700	7.300	0.264	0.287
E1	3.300	3.700	0.130	0.146
e	2.300 (BSC)		0.091 (BSC)	
L	0.750	—	0.030	—
theta	0°	10°	0°	10°

Suggested Pad Layout



Note:

1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$.
3. The pad layout is for reference purposes only.

ORDERING INFORMATION

P/N	PKG	QTY
LM317G-MS	SOT-223	2500

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